





SURFACE MOUNT SWITCHING DIODE ARRAY

Features

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- For General Purpose Switching Applications
- High Conductance
- Two "BAW56" Circuits In One Package
- Lead Free/RoHS Compliant (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- "Green" Device (Notes 4 and 5)

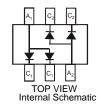
Mechanical Data

- Case: SOT-363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Please see Ordering Information: Note 6, Page 2
- Polarity: See Diagram
- Marking Information: See Page 2
- Weight: 0.006 grams (approximate)

SOT-363







Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V_{RM}	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _R WM V _R	75	V
RMS Reverse Voltage		V _{R(RMS)}	53	V
Forward Continuous Current	(Note 1)	I _{FM}	300	mA
Average Rectified Output Current	(Note 1)	lo	150	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I _{FSM}	2.0 1.0	А

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Power Dissipation	(Note 1)	P_{D}	200	mW
Thermal Resistance Junction to Ambient Air	(Note 1)	$R_{ hetaJA}$	625	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-65 to +150	°C

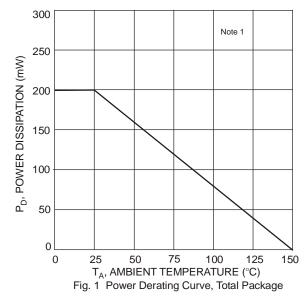
Electrical Characteristics @T_A = 25°C unless otherwise specified

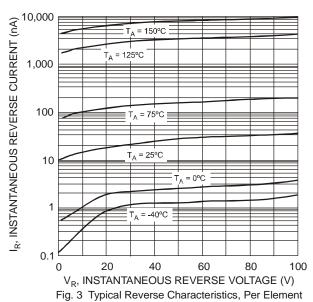
Characteristic	Symbol	Min	Max	Unit	Test Condition	
Reverse Breakdown Voltage	(Note 2)	V _{(BR)R}	75	_	V	$I_R = 2.5 \mu A$
Forward Voltage		V _F	_	0.715 0.855 1.0 1.25	٧	I _F = 1.0mA I _F = 10mA I _F = 50mA I _F = 150mA
Reverse Current	(Note 2)	I _R	_	2.5 50 30 25	μΑ μΑ μΑ nA	$egin{array}{l} V_R = 75V \\ V_R = 75V, T_J = 150^{\circ}C \\ V_R = 25V, T_J = 150^{\circ}C \\ V_R = 20V \\ \end{array}$
Total Capacitance		C _T	_	2.0	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time		t _{rr}	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

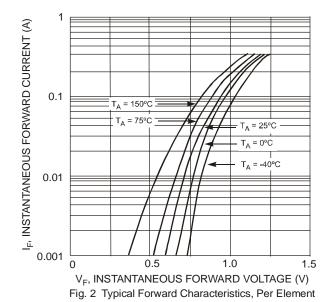
Notes:

- 1. Device mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- Short duration pulse test used to minimize self-heating effect.
- No purposefully added lead.
- Diodes Inc.'s "Green" policy can be found on our website at http://www.diodes.com/products/lead_free/index.php.
- Product manufactured with Date Code UO (week 40, 2007) and newer are built with Green Molding Compound. Product manufactured prior to Date Code UO are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.









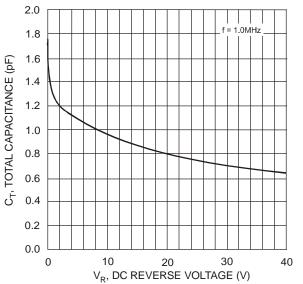


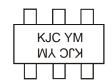
Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Ordering Information (Note 6)

ĺ	Part Number	Case	Packaging			
	BAW56DW-7-F	SOT-363	3000/Tape & Reel			

Notes: 6. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



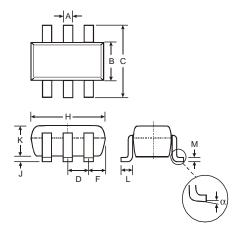
KJC = Product Type Marking Code YM = Date Code Marking Y = Year ex: N = 2002 M = Month ex: 9 = September

Date Code Key

Year	2000	2001	2002	2003	2004	2005	2006	200	7 2008	2009	2010	2011	2012
Code	L	М	N	Р	R	S	Т	U	V	W	Х	Υ	Z
Month	Jan	Feb	Mar	Apr	Ma	y J	un	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5		6	7	8	9	0	Ν	D

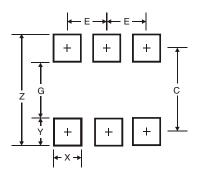


Package Outline Dimensions



SOT-363						
Dim	Min Max					
Α	0.10 0.30					
В	1.15	1.35				
С	2.00	2.20				
D	0.65 No	ominal				
F	0.30 0.40					
Н	1.80 2.20					
J	— 0.10					
K	0.90 1.00					
L	0.25 0.40					
M	0.10 0.25					
α	α 0° 8°					
All Dimensions in mm						

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
Χ	0.42
Υ	0.6
С	1.9
E	0.65

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